

FFP10U60DN

Features

- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- · Power switching circuits





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{RRM}	Peak Repetitive Reverse Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	10	Α	
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	Α	
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C	

Thermal Characteristics

Symbol	Parameter	Value	Units	
R _{e,IC}	Maximum Thermal Resistance, Junction to Case	2.5	°C/W	

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage	_ ()			WW.	V
	I _F = 10A I _F = 10A	$T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	B. V		2.2 2.0	
I _{RM} *	Maximum Instantaneous Reverse Current @ rated V _R	T _C = 25 °C T _C = 100 °C			5 50	μΑ
t _{rr} I _{rr} Q _{rr}	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F =10A, di/dt = 200A/μs)				90 6 270	ns A nC
W _{AVL}	Avalanche Energy		1.0			mJ

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics

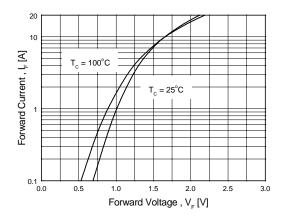


Figure 1. Typical Forward Voltage Drop vs. Forward Current

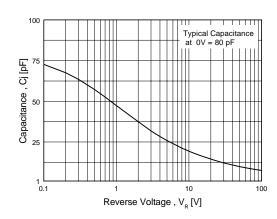


Figure 3. Typical Junction Capacitance

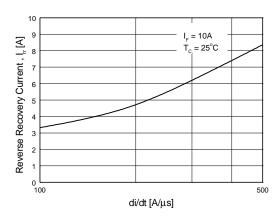


Figure 5. Typical Reverse Recovery Current vs. di/dt

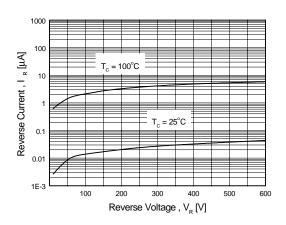


Figure 2. Typical Reverse Current vs. Reverse Voltage

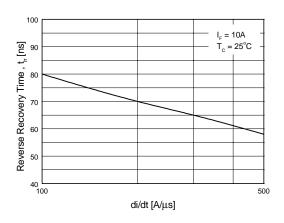


Figure 4. Typical Reverse Recovery Time vs. di/dt

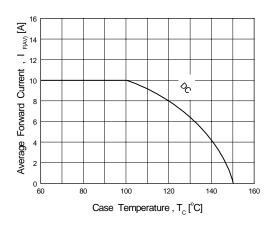
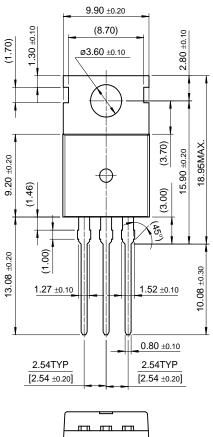


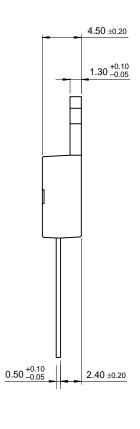
Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-220





10.00 ±0.20

Dimensions in Millimeters

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